

Attorney Docket # 4956-4

1751
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Xiaohui WANG et al.

Serial No.: 09/939,916

Filed: August 27, 2001

For: A Material for Making Hyper Frequency Multi-Layer Chip Inductors with High Performance and Low Sintering Temperature and a Process for Preparing the Material

Examiner: Kopec, Mark T
Group Art: 1751

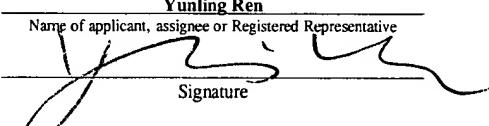
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February 5, 2004

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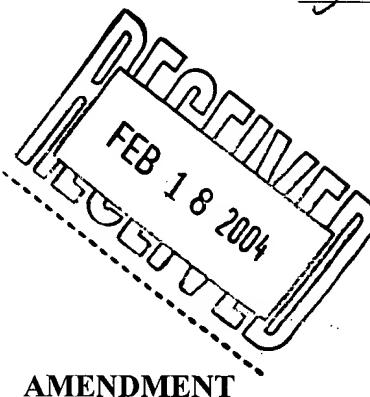
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SIR:

In response to the Office Action dated November 14, 2004, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.